

HBV Series

Features

- 105°C, 10,000 hours assured
- · Low ESR and High ripple current
- · RoHS Compliance



(Tentative)

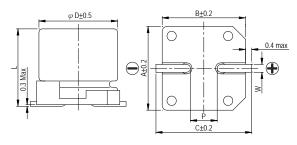
Marking color: Dark Green

Specifications

Items		Performance							
Category Temperature Range				-55°C ~ +105°C					
Capacitance Tolerance				±20%		(at 120	Hz, 20°C)		
	Rated voltage ≤ 63V	I = 0.01C	V or 3 (μA) whiche	ver is greater (after 2 m	ninutes)				
Leakage Current (at 20°C)*	Rated voltage ≥ 80V	I = 0.05C	V or 100 (μA) whic	hever is greater (after 2	2 minutes)				
	Where, C = rated cap	acitance in	μF V = rated D	C working voltage in V	•				
Tanδ (at 120Hz, 20°C)	See Standard Ratings	3							
		т.	est Time	10	0.000 Hrs				
			tance Change	Within ±30					
Endurance		Сарасі	Tanō	Less than 200					
			ESR	Less than 200					
		Leak	age Current	Within s					
	* The above Specifica	tions shall	be satisfied when	the capacitors are resto	ored to 20°C after the r	ated voltage applied wi	th rated		
	ripple current for 10	,000 hours	at 105°C.			· · ·			
Shelf Life	After storage for 1000	hours at 1	05 ± 2°C with no v	oltage applied and the	n being stabilized at +2	20°C, capacitors shall m	eet the		
- C.1.6.11 2.116	limits specified in End	urance. (W	ith voltage treatme	ent)					
		0	taras Obarras	\\/\frac{1}{1} = \ \ \ \ \ \ \ \	00/ af in:kinl				
		Capaci	tance Change Tanδ		% of initial value				
Resistance to Soldering Heat *			ESR		specified value				
		Leak	age Current	Within s					
		200.1	ago carron	***************************************	promou valuo				
Ripple Current &	Frequenc		120 ≦ f < 1k	1k ≤ f < 10k	10k ≤ f < 100k	100k≦ f < 500k			
Frequency Multipliers	Multipl	lier	0.10	0.3	0.6	1.0			

^{*} For any doubt about measured values, measure the leakage current again after the following voltage treatment. Voltage treatment: Applying DC rated voltage to the capacitors for 2 hours at 105 $^{\circ}\text{C}.$

Diagram of Dimensions

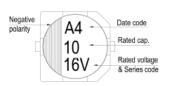


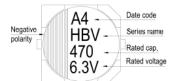
Lead Sp	Lead Spacing and Diameter							
ϕ D	L	Α	В	С	W	P ± 0.2		
6.3	5.8 ± 0.3	6.6	6.6	7.2	0.5 ~ 0.8	2.0		
6.3	7.7 ± 0.3	6.6	6.6	7.2	0.5 ~ 0.8	2.0		
8	10.0 ± 0.5	8.4	8.4	9.0	0.7 ~ 1.1	3.1		
8	12.0 ± 0.5	8.4	8.4	9.0	0.7 ~ 1.1	3.1		
10	10 ± 0.5	10.4	10.4	11.0	0.7 ~ 1.3	4.7		
10	12.5 ± 0.5	10.4	10.4	11.0	0.7 ~ 1.3	4.7		

Marking

$$\phi$$
 D = 6.3 mm

$$\phi D = 8 \sim 10 \text{ mm}$$









Standard Ratings

Dimension: $\phi D \times L(mm)$ Ripple Current: mA/rms at 100k Hz, 105°C

W. V. (V)	Surge Voltage	Capacitance	Size	Tanδ	LC	ESR	Rated R. C.
vv. v. (v)	(V)	(µF)	φD×L(mm)	(120Hz, 20°C)	(µA)	(mΩ/at 100kHz, 20°C Max)	(mA/rms at 100k Hz, 105°C)
		56	6.3 × 5.8	0.14	14	50	1,300
		100	6.3 ×7.7	0.14	25	30	2,000
25V (1E)	28.8	220	8 × 10	0.14	55	27	2,300
		330	10 × 10	0.14	82.5	20	2,500
		330	10 × 12.5	0.16	82.5	16	2,900
		27	6.3 × 5.8	0.12	9.5	60	1,300
25\/ (4\/)	40.3	68	6.3 ×7.7	0.12	23.8	35	2,000
35V (1V)	40.3	150	8 × 10	0.12	52.5	27	2,300
		270	10 × 10	0.12	82.5	20	2,500
		22	6.3 × 5.8	0.10	11	80	1,100
EO) //41 I)	F7 F	33	6.3 ×7.7	0.10	16.5	40	1,600
50V(1H)	57.5	68	8 × 10	0.10	34	30	1,800
		100	10 × 10	0.10	50	28	2,000
		10	6.3 × 5.8	0.08	6.3	120	1,000
		22	6.3 ×7.7	0.08	13.9	80	1,500
63V(1J)	72.5	27	8 × 12	0.08	17	40	1,700
		33	8 × 10	0.08	20.8	40	1,700
		56	10 × 10	0.08	35.3	30	1,800
90\//1\/\	02.0	22	8 × 10	0.08	88	45	1,550
80V(1K)	92.0	33	10 × 10	0.08	132	36	1,700
100\/(24)	115.0	12	10 × 10	0.16	60	80	1,450
100V(2A)	115.0	15	10 × 12.5	0.16	75	60	1,660

Part Numbering System

Carrier Pb-free and PET HBV series 220µF 25V ±20% 8 φ ×10L Tape coating case **1E** Rated Voltage **HBV** <u>221</u> <u>TR</u> <u>0810</u> M

Package Type Terminal Type Capacitance Lead Wire and Series name Capacitance Case size Tolerance Coating Type





HBW Series (Tentative)

Features

- 125°C, 4,000 hours assured
- · Low ESR and High ripple current
- RoHS Compliance



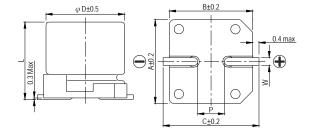
Marking color: Dark Green

Specifications

Items		Performance							
Category Temperature Range		-55°C ~ +125°C							
Capacitance Tolerance			±20%		(at 120Hz, 20°C)				
Leakage Current (at 20°C)*	Rated voltage ≥ 80\	ated voltage ≤ 63V, I = 0.01CV or 3 (µ A) whichever is greater (after 2 minutes) ated voltage ≥ 80V, I = 0.05CV or 100 (µ A) whichever is greater (after 2 minutes) here, C = rated capacitance in µF V = rated DC working voltage in V							
Tanδ (at 120Hz, 20°C)	See Standard Ratings	ee Standard Ratings							
		Test Time 4,000 Hrs Capacitance Change Within ±30% of initial value							
Endurance		Tanδ	anδ Less than 200% of specified value						
		ESR	Less than 200						
		Leakage Current Within specified value							
	ripple current for 4,0	000 hours at 125°C.	,		ated voltage applied with rated				
Shelf Life	After storage for 1000 hours at 125 ± 2°C with no voltage applied and then being stabilized at +20°C, capacitors shall meet the limits specified in Endurance. (With voltage treatment)								
				en being stabilized at +	20℃,capacitors shall meet the				
Resistance to Soldering Heat *			within ±10 Within s Within s	% of initial value pecified value pecified value pecified value	20°C,capacitors shall meet the				
Resistance to Soldering Heat * Ripple Current &		urance. (With voltage treatm Capacitance Change Tanδ ESR Leakage Current	within ±10 Within s Within s	% of initial value pecified value pecified value	20°C,capacitors shall meet the				

^{*} For any doubt about measured values, measure the leakage current again after the following voltage treatment. Voltage treatment: Applying DC rated voltage to the capacitors for 2 hours at 105 °C.

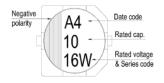
Diagram of Dimensions

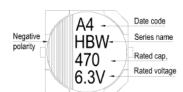


Lead Spacing and Diameter						
ϕ D	L	Α	В	С	W	P ± 0.2
6.3	5.8 ± 0.3	6.6	6.6	7.2	0.5 ~ 0.8	2.0
6.3	7.7 ± 0.3	6.6	6.6	7.2	0.5 ~ 0.8	2.0
8	10.0 ± 0.5	8.4	8.4	9.0	0.7 ~ 1.1	3.1
8	12.0 ± 0.5	8.4	8.4	9.0	0.7 ~ 1.1	3.1
10	10 ± 0.5	10.4	10.4	11.0	0.7 ~ 1.3	4.7
10	12.5 ± 0.5	10.4	10.4	11.0	0.7 ~ 1.3	4.7

Marking

$$\phi$$
 D = 6.3 mm





 $\phi D = 8 \sim 10 \text{ mm}$





(Tentative)

Standard Ratings

Dimension: ϕ D×L(mm) Ripple Current: mA/rms at 100k Hz, 105°C

W. V. (V)	Surge Voltage	Capacitance	Size	Tanδ	LC	ESR	Rated R. C.
vv. v. (v)	(V)	(µF)	φD×L(mm)	(120Hz, 20°C)	(µA)	(mΩ/at 100kHz, 20°C Max)	(mA/rms at 100k Hz, 105°C)
		56	6.3 × 5.8	0.14	14	50	900
25\/ (1E\	25V (1E) 28.8	100	6.3 ×7.7	0.14	25	30	1,400
23V (IL)		220	8 × 10	0.14	55	27	1,600
		330	10 × 10	0.14	82.5	20	2,000
		27	6.3 × 5.8	0.12	9.5	60	900
35V (1V)	40.3	68	6.3 × 7.7	0.12	23.8	35	1,400
337 (17)	40.3	150	8 × 10	0.12	52.5	27	1,600
		270	10 × 10	0.12	82.5	20	2,000
		22	6.3 × 5.8	0.10	11	80	750
E0\//411\	50////	33	6.3 × 7.7	0.10	16.5	40	1,100
50V(1H)	57.5	68	8 × 10	0.10	34	30	1,250
		100	10 × 10	0.10	50	28	1,600
		10	6.3 × 5.8	0.08	6.3	120	700
		22	6.3 × 7.7	0.08	13.9	80	900
63V(1J)	72.5	27	8 × 12	0.08	17	40	1,100
037(13)	72.5	33	8 × 10	0.08	20.8	40	1,100
		56	10 × 10	0.08	35.3	30	1,400
		56	10 × 12.5	0.08	35.3	22	1,440
80V(1K)	92.0	15	10 × 10	0.16	60	70	900
00 V (IK)	32.0	18	10 × 12.5	0.16	72	50	1,100
100\/(24)	115.0	12	10 × 10	0.16	60	80	870
100V(2A) 115.0	113.0	15	10 × 12.5	0.16	75	60	1,000

Part Numbering System

HBW series	220μF	±20%	25V	Carrier Tape		8 <i>ф</i> ×10L	Pb-free and PET coating case
<u>HBW</u>	<u>221</u>	<u>M</u>	<u>1E</u>	<u>TR</u>	-	<u>0810</u>	
Series name	Capacitance	Capacitance Tolerance	Rated Voltage	Package Type	Terminal Type	Case size	Lead Wire and Coating Type



Reflow Conditions for SMD Type

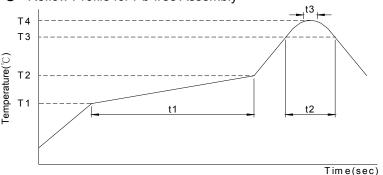
Recommended Land Pattern and Size

///: pad

Recommended Soldering Methods

Method	Reflow soldering	Soldering iron	Flow soldering
Advisability	0	0	X
	Recommended	Recommended	Not Recommended

Reflow Profile for Pb-free Assembly



Test Conditions

٦	Hybrid capcitor					
W.						
Case						
Temp. Preheat (T1 ~ T2, °C)		150 ~ 180			80	
	Time(t1) (Max, secs)	120				
Duration	Temp. (T3, °C)	200	2	17	230	
	Time(t2) (Max, secs)	70 40		0	30	
Peak	Temp Peak (T4, °C)		250		260	
Time (t3, secs)		5				
Reflo	Reflow cycles			2 1		

- (2) Soldering precautions
 - 1. Elements related to the reflow soldering temperature
 - * Product size: The temperature rises slower as the size gets bigger.
 - * Product location: The center part of the PCB tends to have a lower temperature than the
 - * PCB size: The PCB temperature rises slower as the area and/or thickness of the PCB gets
 - 2. Repeated reflowing
 - * Avoid reflowing twice if possible.
 - * If repeated reflowing is unavoidable, contact us after measuring the first and the second reflow profiles and reflow interval at your side.
 - * Do not attempt to reflow three times.
 - 3. Soldering with soldering iron observe the following conditions.
 - * The iron tip temperature: 350±5°C
 - * Soldering time: 3+1/-0 seconds.

- * Please contact our representative if your condition is higher.
- * Please ensure that the capacitor became cold enough to the room temperature (5 ~ 35°C) before the second reflow.
- * Consult with us when performing reflow profile in IPC / JEDEC (J-STD-020)

Attention for Conductive Polymer Hybrid Aluminum Electrolytic Capacitors

Reflow soldering may reduce the capacitance of products before or after soldering even if soldering conditions stipulated in Recommendable Reflow Condition are met.

Though the actual reflow conditions are subject to change depending on the kind of reflow soldering method, please be aware that the peak temperature at the top of Al-case and electrode terminals should not exceed peak temperature.

(1) Method is as follows.

Reflow soldering condition.

The following temperature profile condition should be observed for soldering. (For higher temperature, pleases contact us after measuring the capacitor's product temperature profile at your side.

Case size

 6.3ϕ

8φ

10*φ*

Unit: mm

С

1.6

2.5

2.5

Land size

3.5

3.5

4.0

а

1.9

3.0

4.0

Product temperature will rise slower as the product size gets bigger. It is not necessary to adjust the reflow furnace temperature setting according to the product size, for example, φ4 and φ10 products can be mixed on one PCB for reflowing.